



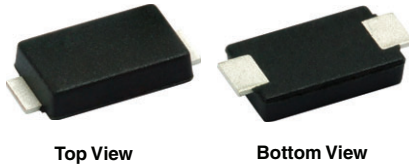
**THE DATASHEET OF
SE30AFDHM3/6B**





Surface Mount ESD Capability Rectifiers

eSMP® Series



SlimSMA (DO-221AC)



FEATURES

- Very low profile - typical height of 0.95 mm
- Ideal for automated placement
- Oxide planar chip junction
- Low forward voltage drop, low leakage current
- ESD capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



ADDITIONAL RESOURCES



TYPICAL APPLICATIONS

General purpose, power line polarity protection, in both consumer and automotive applications.

MECHANICAL DATA

Case: SlimSMA (DO-221AC)

Molding compound meets UL 94 V-0 flammability rating
Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes the cathode end

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	3.0 A
V_{RRM}	100 V, 200 V, 400 V, 600 V
I_{FSM}	40 A
V_F at $I_F = 3.0$ A ($T_A = 125$ °C)	0.86 V
I_R	10 μ A
T_J max.	175 °C
Package	SlimSMA (DO-221AC)
Circuit configuration	Single

MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted)						
PARAMETER	SYMBOL	SE30AFB	SE30AFD	SE30AFG	SE30AFJ	UNIT
Device marking code		S3B	S3D	S3G	S3J	
Maximum repetitive peak reverse voltage	V_{RRM}	100	200	400	600	V
Maximum DC forward current	$I_F^{(1)}$	3.0				A
	$I_F^{(2)}$	1.4				
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I_{FSM}	40				A
Operating junction and storage temperature range	T_J, T_{STG}	-55 to +175				°C

Notes

(1) Mounted on 15 mm x 15 mm pad areas, 2 oz. FR4 PCB

(2) Free air, mounted on recommended copper pad area

**ELECTRICAL CHARACTERISTICS** ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)

PARAMETER	TEST CONDITIONS	SYMBOL	TYP.	MAX.	UNIT	
Instantaneous forward voltage	$I_F = 1.5\text{ A}$	$T_A = 25\text{ }^\circ\text{C}$	$V_F^{(1)}$	0.91	-	V
	$I_F = 3.0\text{ A}$			0.97	1.1	
	$I_F = 1.5\text{ A}$	$T_A = 125\text{ }^\circ\text{C}$		0.79	-	
	$I_F = 3.0\text{ A}$			0.86	0.98	
Reverse current	Rated V_R	$I_R^{(2)}$	-	10	μA	
			$T_A = 125\text{ }^\circ\text{C}$	13		100
Typical reverse recovery time	$I_F = 0.5\text{ A}, I_R = 1.0\text{ A}, I_{rr} = 0.25\text{ A}$		t_{rr}	1.5	-	μs
Typical junction capacitance	4.0 V, 1 MHz		C_J	19	-	pF

Notes

- (1) Pulse test: 300 μs pulse width, 1 % duty cycle
(2) Pulse test: Pulse width $\leq 40\text{ ms}$

THERMAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)

PARAMETER	SYMBOL	SE30AFB	SE30AFD	SE30AFG	SE30AFJ	UNIT
Typical thermal resistance	$R_{\theta JA}^{(1)}$	125				$^\circ\text{C/W}$
	$R_{\theta JM}^{(2)}$	12				

Notes

- (1) Free air, mounted on recommended PCB, 1 oz. pad area; thermal resistance $R_{\theta JA}$ - junction to ambient
(2) Mounted on 15 mm x 15 mm pad areas, 2 oz. FR4 PCB; $R_{\theta JM}$ - junction to mount

IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)

STANDARD	TEST TYPE	TEST CONDITIONS	SYMBOL	CLASS	VALUE
AEC-Q101-001	Human body model (contact mode)	$C = 100\text{ pF}, R = 1.5\text{ k}\Omega$	V_C	H3B	$> 8\text{ kV}$

ORDERING INFORMATION (Example)

PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
SE30AFJ-M3/6A	0.032	6A	3500	7" diameter plastic tape and reel
SE30AFJ-M3/6B	0.032	6B	14 000	13" diameter plastic tape and reel
SE30AFJHM3/6A ⁽¹⁾	0.032	6A	3500	7" diameter plastic tape and reel
SE30AFJHM3/6B ⁽¹⁾	0.032	6B	14 000	13" diameter plastic tape and reel

Note

- (1) AEC-Q101 qualified



RATINGS AND CHARACTERISTICS CURVES ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)

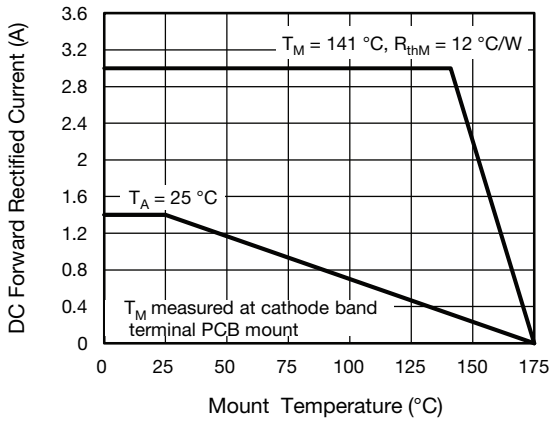


Fig. 1 - Maximum Forward Current Derating Curve

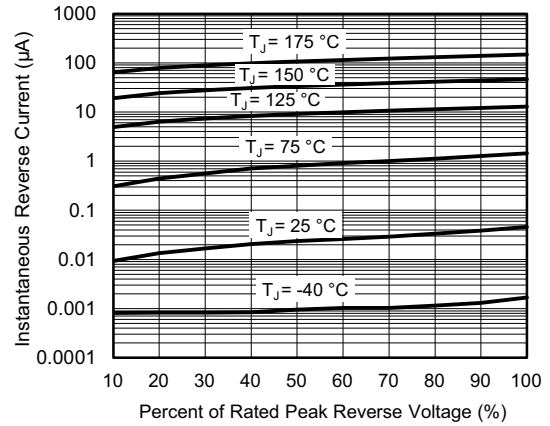


Fig. 4 - Typical Reverse Leakage Characteristics

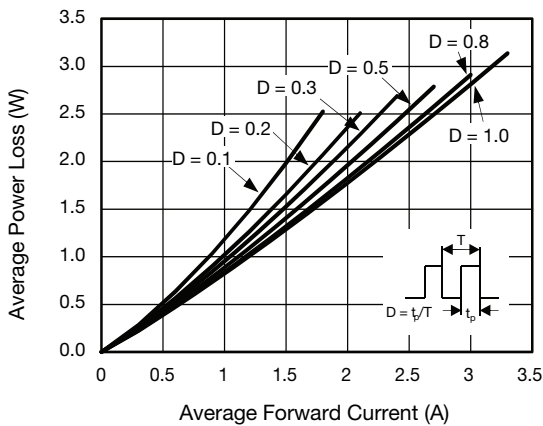


Fig. 2 - Forward Power Loss Characteristics

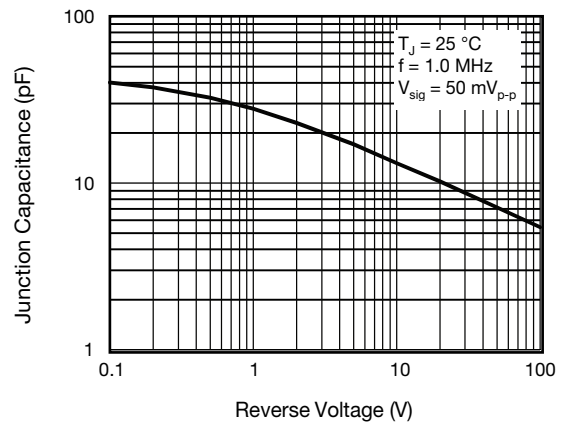


Fig. 5 - Typical Junction Capacitance

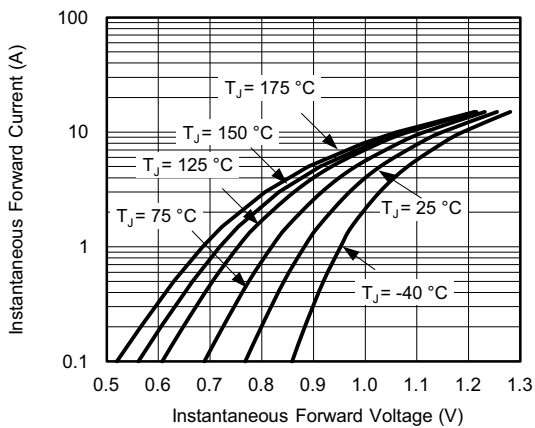


Fig. 3 - Typical Instantaneous Forward Characteristics

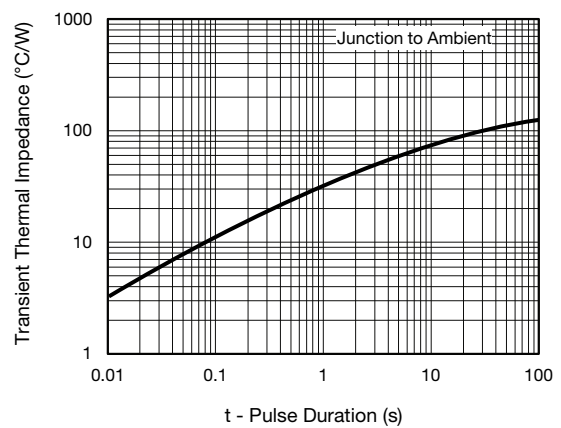


Fig. 6 - Transient Thermal Impedance

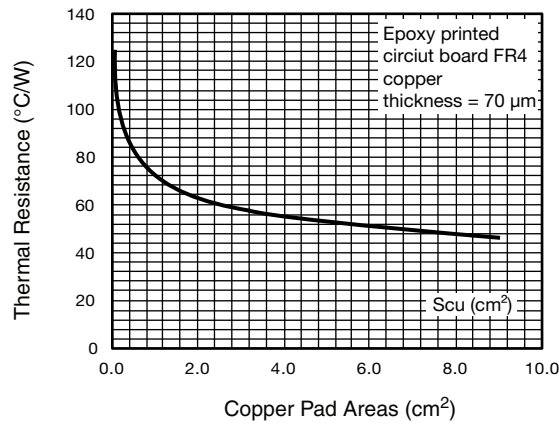
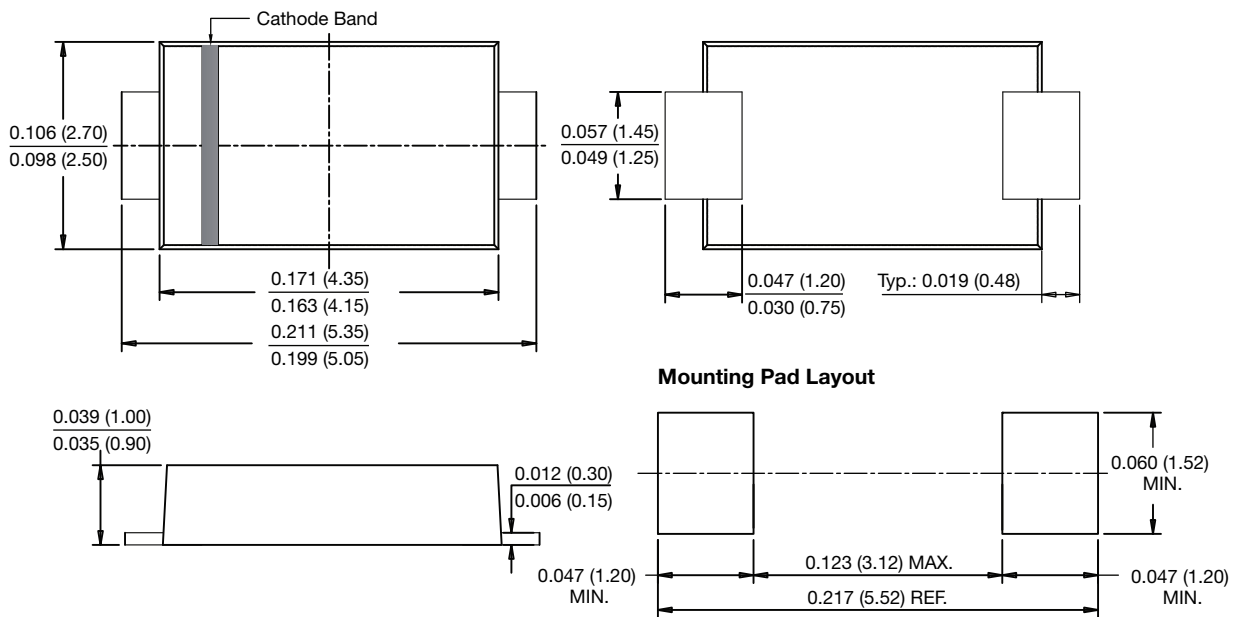


Fig. 7 - Thermal Resistance Junction to Ambient vs. Copper Pad Areas

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

SlimSMA (DO-221AC)





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